

Dual N-channel MOSFET

ELM51932EA-S

<http://www.elm-tech.com>

■ General description

ELM51932EA-S uses advanced trench technology to provide excellent $R_{ds(on)}$, low gate charge and operation with gate voltages as low as 2.5V and internal ESD protection.

■ Features

- $V_{ds}=30V$
- $I_d=1.8A$
- $R_{ds(on)} = 450m\Omega$ ($V_{gs}=4.5V$)
- $R_{ds(on)} = 600m\Omega$ ($V_{gs}=2.5V$)
- ESD protected

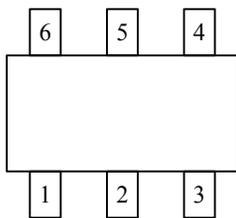
■ Maximum absolute ratings

$T_a=25^\circ C$. Unless otherwise noted.

Parameter	Symbol	Limit	Unit
Drain-source voltage	V_{ds}	30	V
Gate-source voltage	V_{gs}	± 12	V
Continuous drain current($T_j=150^\circ C$)	I_d	$T_a=25^\circ C$	1.8
		$T_a=70^\circ C$	1.0
Pulsed drain current	I_{dm}	6	A
Power dissipation	P_d	$T_c=25^\circ C$	0.3
		$T_c=70^\circ C$	0.2
Operating junction temperature	T_j	- 55 to 150	$^\circ C$
Storage temperature range	T_{stg}	- 55 to 150	$^\circ C$

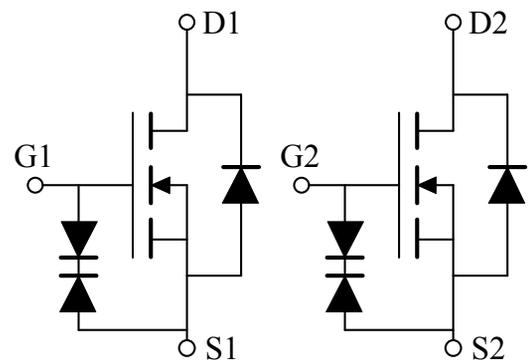
■ Pin configuration

SC-70-6(TOP VIEW)



Pin No.	Pin name
1	SOURCE1
2	GATE1
3	DRAIN2
4	SOURCE2
5	GATE2
6	DRAIN1

■ Circuit



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■ Electrical characteristics

Ta=25°C. Unless otherwise noted.

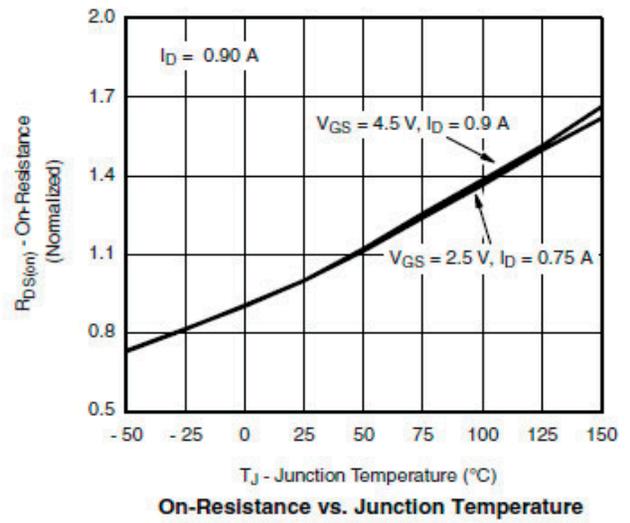
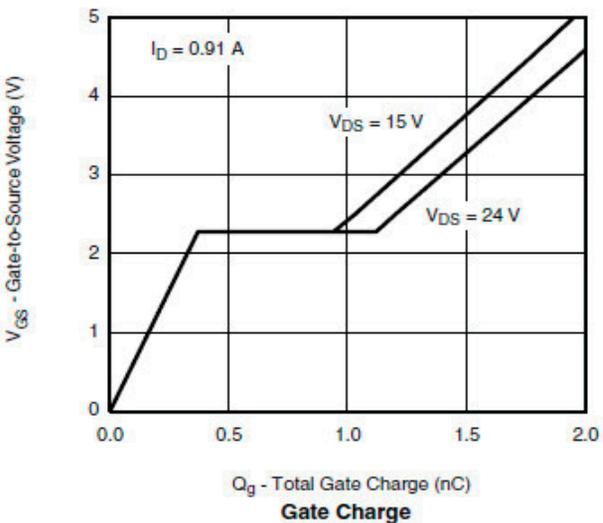
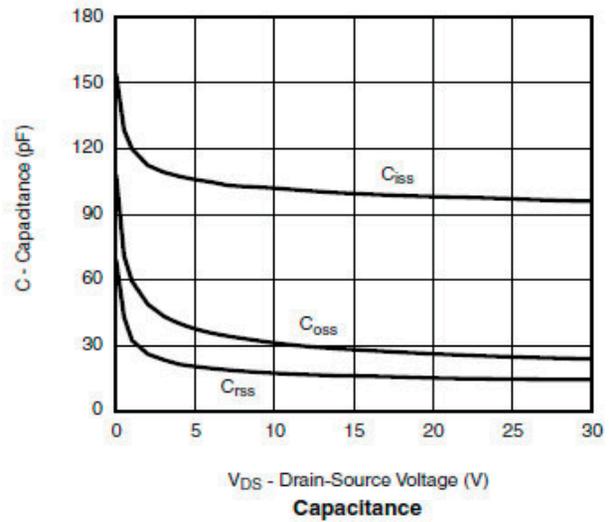
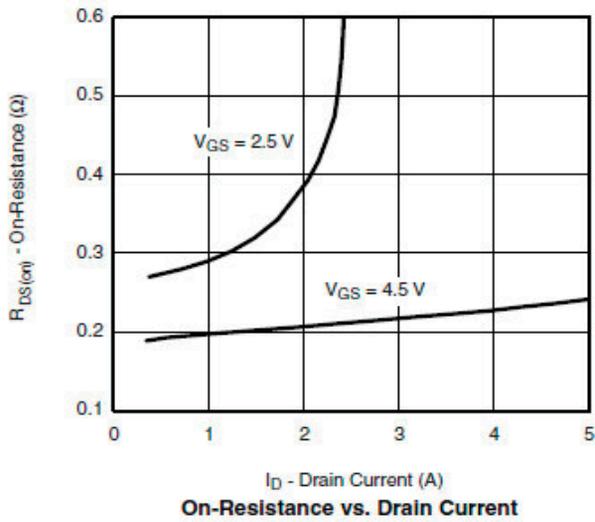
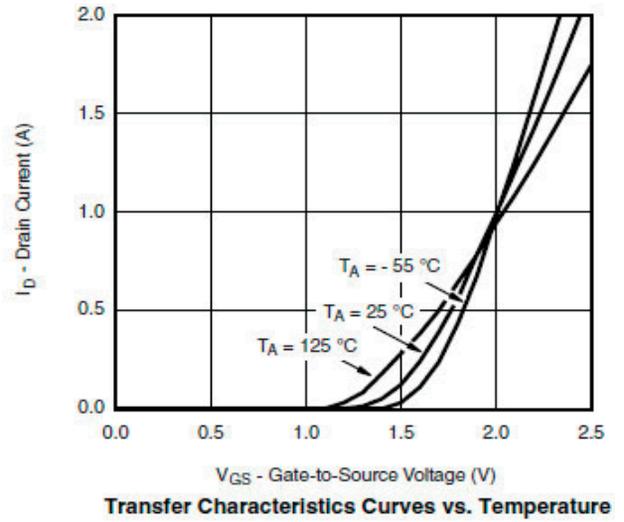
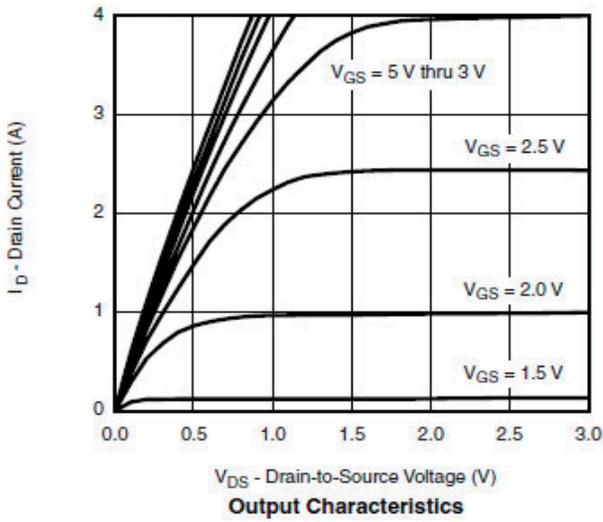
Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit
STATIC PARAMETERS						
Drain-source breakdown voltage	BV _{dss}	I _d =250μA, V _{gs} =0V	30			V
Zero gate voltage drain current	I _{dss}	V _{ds} =24V, V _{gs} =0V Ta=85°C			1	μA
					5	
Gate-source leakage current	I _{gss}	V _{ds} =0V, V _{gs} =±12V			±5	mA
Gate threshold voltage	V _{gs(th)}	V _{ds} =V _{gs} , I _d =250μA	0.5		1.5	V
On state drain current	I _{d(on)}	V _{gs} =4.5V, V _{ds} ≥5V	1.8			A
Static drain-source on-resistance	R _{ds(on)}	V _{gs} =4.5V, I _d =1.5A		400	450	mΩ
		V _{gs} =2.5V, I _d =1.2A		550	600	
Forward transconductance	G _{fs}	V _{ds} =10V, I _d =1.0A		1		S
Diode forward voltage	V _{sd}	I _s =1.0A, V _{gs} =0V		0.65	1.20	V
Max. body-diode continuous current	I _s				1.0	A
DYNAMIC PARAMETERS						
Input capacitance	C _{iss}	V _{gs} =0V, V _{ds} =15V, f=1MHz		85		pF
Output capacitance	C _{oss}			25		pF
Reverse transfer capacitance	C _{rss}			15		pF
SWITCHING PARAMETERS						
Total gate charge	Q _g	V _{gs} =4.5V, V _{ds} =15V, I _d ≐1.2A		1.4	1.8	pC
Gate-source charge	Q _{gs}			0.3		pC
Gate-drain charge	Q _{gd}			0.6		pC
Turn-on delay time	t _{d(on)}	V _{gs} =4.5V, V _{ds} =15V R _L =20Ω, I _d ≐1.2A R _{gen} =1.0Ω		15	25	ns
Turn-on rise time	t _r			25	45	ns
Turn-off delay time	t _{d(off)}			15	25	ns
Turn-off fall time	t _f			10	20	ns

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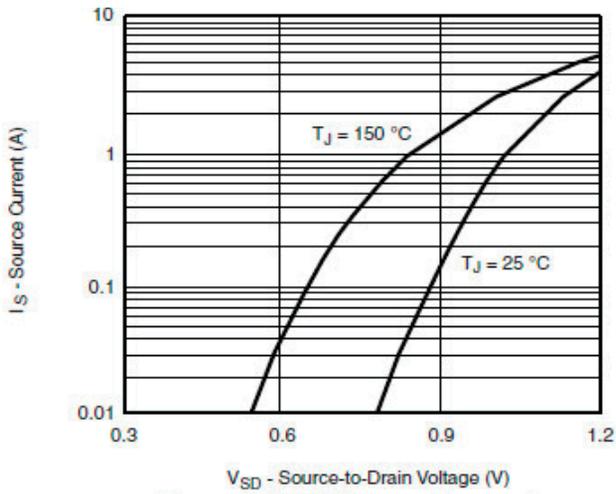
■ Typical electrical and thermal characteristics



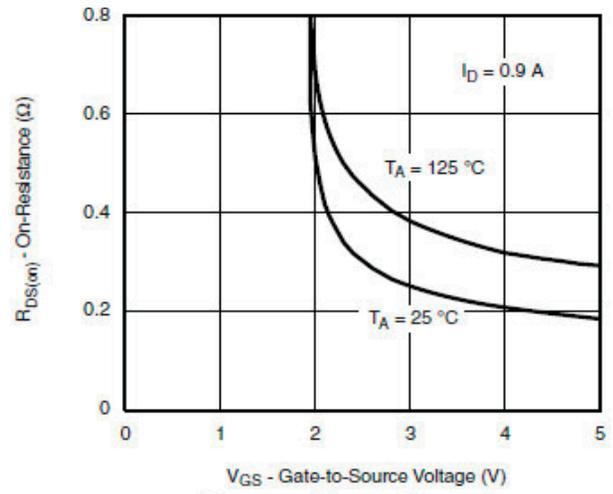
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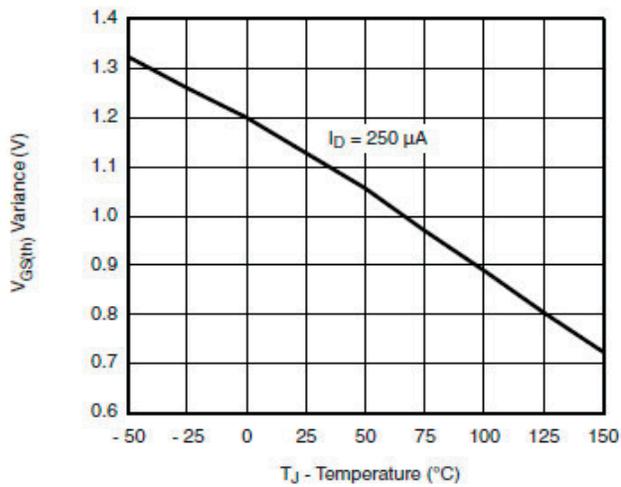
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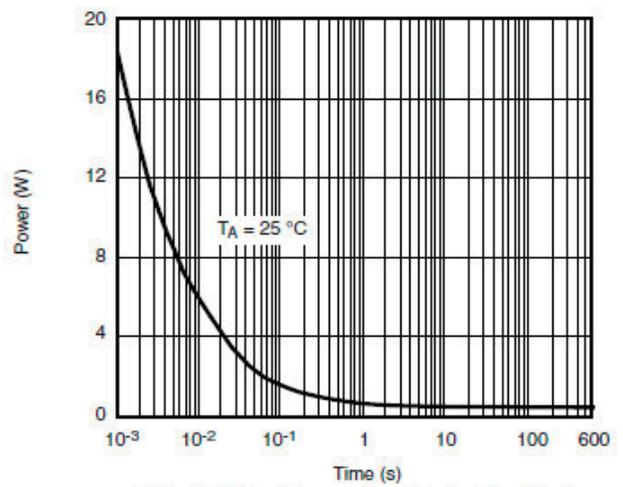
Forward Diode Voltage vs. Temperature



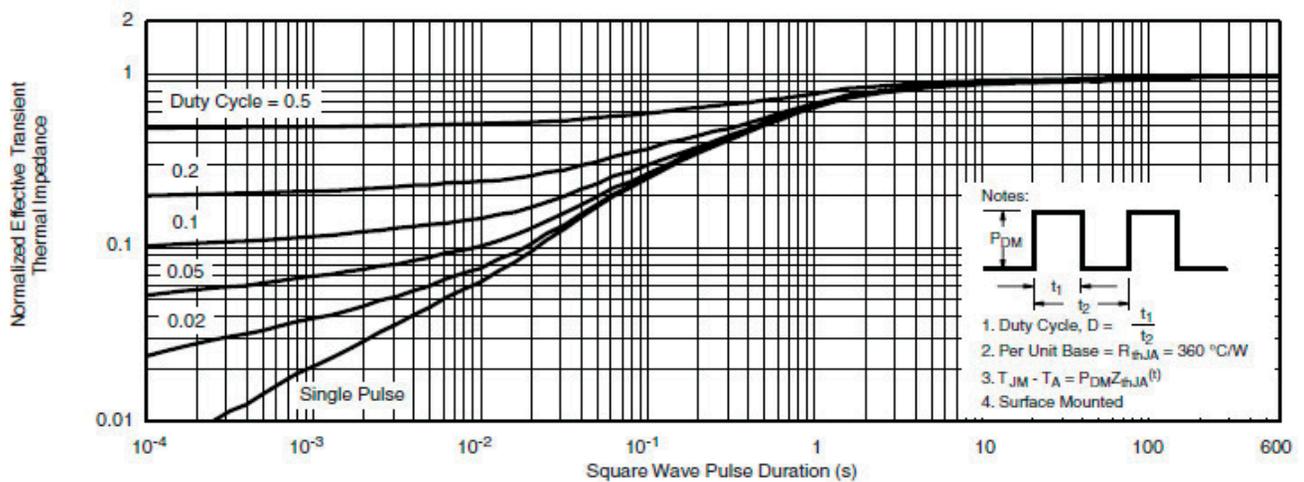
$R_{DS(on)}$ vs. V_{GS} vs. Temperature



Threshold Voltage



Single Pulse Power, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Ambient

- Notes:
-
1. Duty Cycle, $D = \frac{t_1}{t_2}$
 2. Per Unit Base = $R_{thJA} = 360^\circ\text{C/W}$
 3. $T_{JM} - T_A = PDM Z_{thJA}^{(t)}$
 4. Surface Mounted

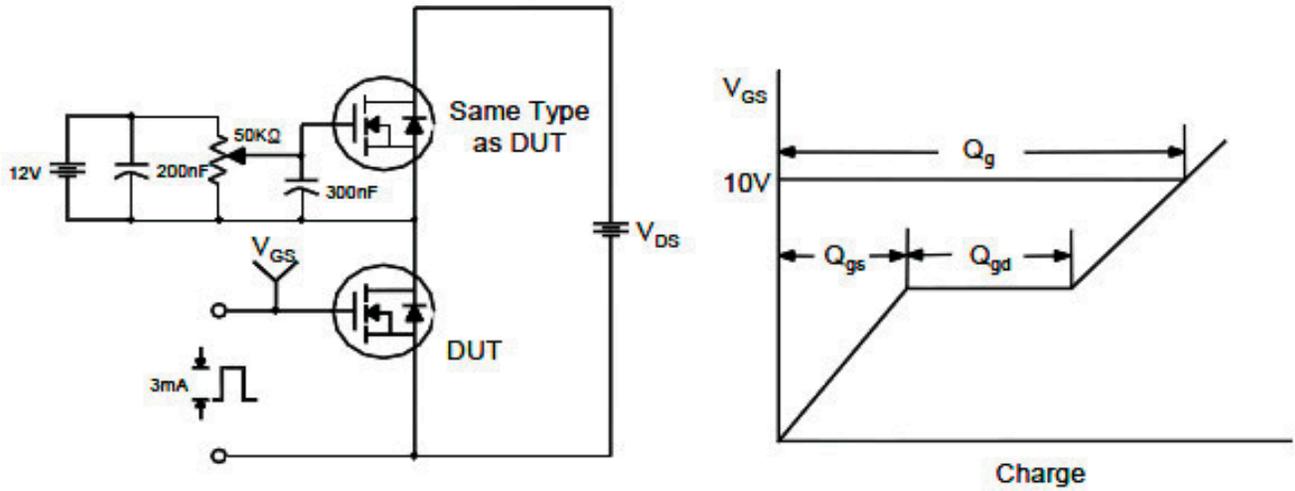
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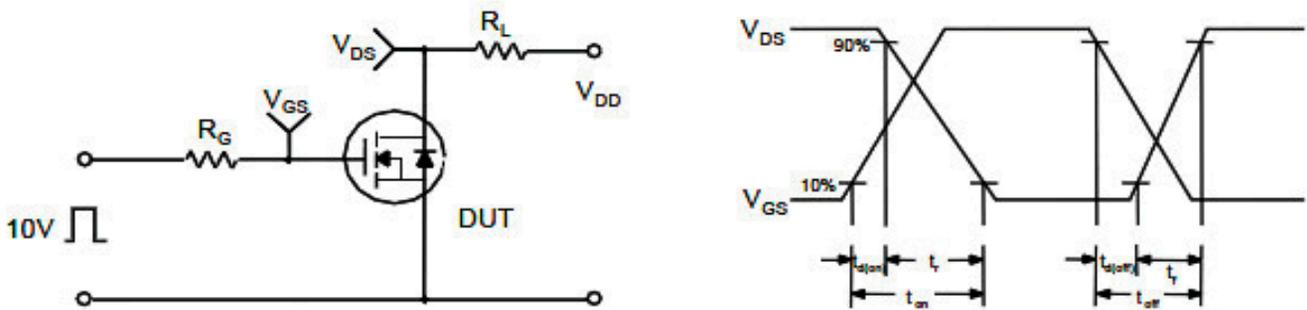
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■ Test circuit and waveform

Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching Test Circuit & Waveforms

